

## HIGH OUTPUT RS-485 TRANSCEIVERS

### FEATURES

- Minimum Differential Output Voltage of 2.5 V Into a 54-Ω Load
- Open-Circuit, Short-Circuit, and Idle-Bus Failsafe Receiver
- 1/8<sup>th</sup> Unit-Load Option Available (Up to 256 Nodes on the Bus)
- Bus-Pin ESD Protection Exceeds 16 kV HBM
- Driver Output Slew Rate Control Options
- Electrically Compatible With ANSI TIA/EIA-485-A Standard
- Low-Current Standby Mode : 1 μA Typical
- Glitch-Free Power-Up and Power-Down Protection for Hot-Plugging Applications
- Pin Compatible With Industry Standard SN75176

### APPLICATIONS

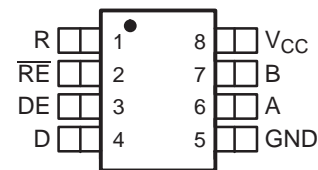
- Data Transmission Over Long or Lossy Lines or Electrically Noisy Environments
- Profibus Line Interface
- Industrial Process Control Networks
- Point-of-Sale (POS) Networks
- Electric Utility Metering
- Building Automation
- Digital Motor Control

### DESCRIPTION

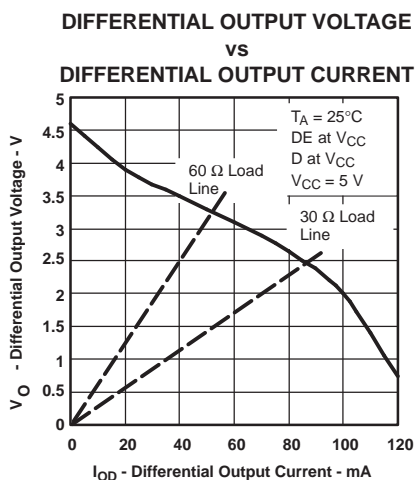
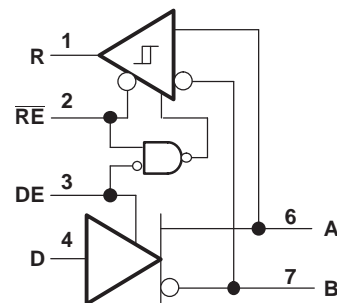
The SN65HVD05, SN75HVD05, SN65HVD06, SN75HVD06, SN65HVD07, and SN75HVD07 combine a 3-state differential line driver and differential line receiver. They are designed for balanced data transmission and interoperate with ANSI TIA/EIA-485-A and ISO 8482E standard-compliant devices. The driver is designed to provide a differential output voltage greater than that required by these standards for increased noise margin. The drivers and receivers have active-high and active-low enables respectively, which can be externally connected together to function as direction control.

The driver differential outputs and receiver differential inputs connect internally to form a differential input/output (I/O) bus port that is designed to offer minimum loading to the bus whenever the driver is disabled or not powered. These devices feature wide positive and negative common-mode voltage ranges, making them suitable for party-line applications.

**D OR P PACKAGE  
(TOP VIEW)**



**LOGIC DIAGRAM  
(POSITIVE LOGIC)**



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### ORDERING INFORMATION<sup>(1)</sup>

| SIGNALING RATE | UNIT LOAD | DRIVER OUTPUT SLOPE CONTROL | T <sub>A</sub> | PART NUMBER <sup>(2)</sup> |            | MARKED AS                           |                                 |
|----------------|-----------|-----------------------------|----------------|----------------------------|------------|-------------------------------------|---------------------------------|
|                |           |                             |                |                            |            | PLASTIC DUAL-IN-LINE PACKAGE (PDIP) | SMALL OUTLINE IC (SOIC) PACKAGE |
| 40 Mbps        | 1/2       | No                          | –40°C to 85°C  | SN65HVD05D                 | SN65HVD05P | 65HVD05                             | VP05                            |
| 10 Mbps        | 1/8       | Yes                         |                | SN65HVD06D                 | SN65HVD06P | 65HVD06                             | VP06                            |
| 1 Mbps         | 1/8       | Yes                         |                | SN65HVD07D                 | SN65HVD07P | 65HVD07                             | VP07                            |
| 40 Mbps        | 1/2       | No                          | 0°C to 70°C    | SN75HVD05D                 | SN75HVD05P | 75HVD05                             | VN05                            |
| 10 Mbps        | 1/8       | Yes                         |                | SN75HVD06D                 | SN75HVD06P | 75HVD06                             | VN06                            |
| 1 Mbps         | 1/8       | Yes                         |                | SN75HVD07D                 | SN75HVD07P | 75HVD07                             | VN07                            |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) The D package is available taped and reeled. Add an R suffix to the device type (i.e., SN65HVD05DR).

### PACKAGE DISSIPATION RATINGS

(See [Figure 12](#) and [Figure 13](#))

| PACKAGE          | T <sub>A</sub> ≤ 25°C<br>POWER RATING | DERATING FACTOR <sup>(1)</sup><br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|------------------|---------------------------------------|---|---------------------------------------|---------------------------------------|
| D <sup>(2)</sup> | 710 mW                                | 5.7 mW/°C   | 455 mW                                | 369 mW                                |
| D <sup>(3)</sup> | 1282 mW                               | 10.3 mW/°C  | 821 mW                                | 667 mW                                |
| P                | 1000 mW                               | 8.0 m W/°C  | 640 mW                                | 520 mW                                |

- (1) This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.
- (2) Tested in accordance with the Low-K thermal metric definitions of EIA/JESD51-3
- (3) Tested in accordance with the High-K thermal metric definitions of EIA/JESD51-7

### ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted<sup>(1)(2)</sup>

|   |                                     | SN65HVD05, SN65HVD06, SN65HVD07<br>SN75HVD05, SN75HVD06, SN75HVD07 |       |
|---|-------------------------------------|--|-------|
| Supply voltage range, V <sub>CC</sub>   |                                     | –0.3 V to 6 V  |       |
| Voltage range at A or B   |                                     | –9 V to 14 V   |       |
| Input voltage range at D, DE, R or $\overline{RE}$  |                                     | –0.5 V to V <sub>CC</sub> + 0.5 V                                  |       |
| Voltage input range, transient pulse, A and B, through 100 Ω (see <a href="#">Figure 11</a> ) |                                     | –50 V to 50 V  |       |
| Receiver output current, I <sub>O</sub>   |                                     | –11 mA to 11mA   |       |
| Electrostatic discharge   | Human body model <sup>(3)</sup>     | A, B, and GND  | 16 kV |
|   |                                     | All pins   | 4 kV  |
|   | Charged-device model <sup>(4)</sup> | All pins   | 1 kV  |
| Continuous total power dissipation  |                                     | See Dissipation Rating Table                                       |       |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
- (3) Tested in accordance with JEDEC Standard 22, Test Method A114-A.
- (4) Tested in accordance with JEDEC Standard 22, Test Method C101.

## RECOMMENDED OPERATING CONDITIONS

|   |                        | MIN               | NOM | MAX | UNIT |
|---|------------------------|-------------------|-----|-----|------|
| Supply voltage, $V_{CC}$  |                        | 4.5               |     | 5.5 | V    |
| Voltage at any bus terminal (separately or common mode) $V_I$ or $V_{IC}$ |                        | -7 <sup>(1)</sup> |     | 12  | V    |
| High-level input voltage, $V_{IH}$  | D, DE, $\overline{RE}$ | 2                 |     |     | V    |
| Low-level input voltage, $V_{IL}$   | D, DE, $\overline{RE}$ |                   |     | 0.8 | V    |
| Differential input voltage, $V_{ID}$ (see <a href="#">Figure 7</a> )      |                        | -12               |     | 12  | V    |
| High-level output current, $I_{OH}$                                       | Driver                 | -100              |     |     | mA   |
|   | Receiver               | -8                |     |     |      |
| Low-level output current, $I_{OL}$  | Driver                 |                   |     | 100 | mA   |
|   | Receiver               |                   |     | 8   |      |
| Operating free-air temperature, $T_A$                                     | SN65HVD05              | -40               |     | 85  | °C   |
|   | SN65HVD06              |                   |     |     |      |
|   | SN65HVD07              |                   |     |     |      |
|   | SN75HVD05              | 0                 |     | 70  | °C   |
|   | SN75HVD06              |                   |     |     |      |
|   | SN75HVD07              |                   |     |     |      |

(1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.

## DRIVER ELECTRICAL CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

| PARAMETER           |  | TEST CONDITIONS  |   | MIN  | TYP <sup>(1)</sup> | MAX      | UNIT    |
|---------------------|--|--|---|------|--------------------|----------|---------|
| $V_{IK}$            | Input clamp voltage                                | $I_I = -18$ mA   |   | -1.5 |                    |          | V       |
| $ V_{OD} $          | Differential output voltage                        | No Load  |   |      |                    | $V_{CC}$ | V       |
|                     |  | $R_L = 54 \Omega$ , See <a href="#">Figure 4</a>                     |   | 2.5  |                    |          |         |
|                     |  | $V_{test} = -7$ V to 12 V, See <a href="#">Figure 2</a>              |   | 2.2  |                    |          |         |
| $\Delta V_{OD} $    | Change in magnitude of differential output voltage | See <a href="#">Figure 4</a> and <a href="#">Figure 2</a>            |   | -0.2 |                    | 0.2      | V       |
| $V_{OC(SS)}$        | Steady-state common-mode output voltage            | See <a href="#">Figure 3</a>   |   | 2.2  |                    | 3.3      | V       |
| $\Delta V_{OC(SS)}$ | Change in steady-state common-mode output voltage  | See <a href="#">Figure 3</a>   |   | -0.1 |                    | 0.1      | V       |
| $V_{OC(PP)}$        | Peak-to-peak common-mode output voltage            | HVD05  | See <a href="#">Figure 3</a>                          |      | 600                |          | mV      |
|                     |  | HVD06  |   | 500  |                    |          |         |
|                     |  | HVD07  |   | 900  |                    |          |         |
| $I_{OZ}$            | High-impedance output current                      | See receiver input currents  |   |      |                    |          |         |
| $I_I$               | Input current                                      | D  |   | -100 |                    | 0        | $\mu$ A |
|                     |  | DE   |   | 0    |                    | 100      |         |
| $I_{OS}$            | Short-circuit output current                       | $-7$ V $\leq V_O \leq 12$ V  |   | -250 |                    | 250      | mA      |
| $C_{(diff)}$        | Differential output capacitance                    | $V_{ID} = 0.4 \sin(4E6\pi t) + 0.5$ V, DE at 0 V                     |   |      | 16                 |          | pF      |
| $I_{CC}$            | Supply current                                     | $\overline{RE}$ at $V_{CC}$ ,<br>D and DE at $V_{CC}$ ,<br>No load   | Receiver disabled<br>and driver enabled               |      | 9                  | 15       | mA      |
|                     |  | $\overline{RE}$ at $V_{CC}$ ,<br>D at $V_{CC}$ DE at 0 V,<br>No load | Receiver disabled<br>and driver disabled<br>(standby) |      | 1                  | 5        | $\mu$ A |
|                     |  | $\overline{RE}$ at 0 V,<br>D and DE at $V_{CC}$ ,<br>No load         | Receiver enabled<br>and driver enabled                |      | 9                  | 15       | mA      |

(1) All typical values are at 25°C and with a 5-V supply.

## DRIVER SWITCHING CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

| PARAMETER                          |   | TEST CONDITIONS | MIN  | TYP <sup>(1)</sup> | MAX | UNIT |
|------------------------------------|---|-----------------|--|--------------------|-----|------|
| t <sub>PLH</sub>                   | Propagation delay time, low-to-high-level output            | HVD05           |  | 6.5                | 11  | ns   |
|                                    |   | HVD06           |  | 27                 | 40  |      |
|                                    |   | HVD07           |  | 250                | 400 |      |
| t <sub>PHL</sub>                   | Propagation delay time, high-to-low-level output            | HVD05           |  | 6.5                | 11  | ns   |
|                                    |   | HVD06           |  | 27                 | 40  |      |
|                                    |   | HVD07           |  | 250                | 400 |      |
| t <sub>r</sub>                     | Differential output signal rise time                        | HVD05           |  | 2.7                | 3.6 | ns   |
|                                    |   | HVD06           |  | 18                 | 28  |      |
|                                    |   | HVD07           |  | 150                | 300 |      |
| t <sub>f</sub>                     | Differential output signal fall time                        | HVD05           |  | 2.7                | 3.6 | ns   |
|                                    |   | HVD06           |  | 18                 | 28  |      |
|                                    |   | HVD07           |  | 150                | 300 |      |
| t <sub>sk(p)</sub>                 | Pulse skew ( t <sub>PHL</sub> - t <sub>PLH</sub>  )         | HVD05           |  |                    | 2   | ns   |
|                                    |   | HVD06           |  |                    | 2.5 |      |
|                                    |   | HVD07           |  |                    | 10  |      |
| t <sub>sk(pp)</sub> <sup>(2)</sup> | Part-to-part skew   | HVD05           |  |                    | 3.5 | ns   |
|                                    |   | HVD06           |  |                    | 14  |      |
|                                    |   | HVD07           |  |                    | 100 |      |
| t <sub>PZH1</sub>                  | Propagation delay time, high-impedance-to-high-level output | HVD05           |  |                    | 25  | ns   |
|                                    |   | HVD06           |  |                    | 45  |      |
|                                    |   | HVD07           |  |                    | 250 |      |
| t <sub>PHZ</sub>                   | Propagation delay time, high-level-to-high-impedance output | HVD05           |  |                    | 25  | ns   |
|                                    |   | HVD06           |  |                    | 60  |      |
|                                    |   | HVD07           |  |                    | 250 |      |
| t <sub>PZL1</sub>                  | Propagation delay time, high-impedance-to-low-level output  | HVD05           |  |                    | 15  | ns   |
|                                    |   | HVD06           |  |                    | 45  |      |
|                                    |   | HVD07           |  |                    | 200 |      |
| t <sub>PLZ</sub>                   | Propagation delay time, low-level-to-high-impedance output  | HVD05           |  |                    | 14  | ns   |
|                                    |   | HVD06           |  |                    | 90  |      |
|                                    |   | HVD07           |  |                    | 550 |      |
| t <sub>PZH2</sub>                  | Propagation delay time, standby-to-high-level output        |                 | R <sub>L</sub> = 110Ω, $\overline{RE}$ at 3 V,<br>See Figure 5 |                    | 6   | μs   |
| t <sub>PZL2</sub>                  | Propagation delay time, standby-to-low-level output         |                 | R <sub>L</sub> = 110Ω, $\overline{RE}$ at 3 V,<br>See Figure 6 |                    | 6   | μs   |

(1) All typical values are at 25°C and with a 5-V supply.

(2) t<sub>sk(pp)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## RECEIVER ELECTRICAL CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

| PARAMETER    |  | TEST CONDITIONS  |   | MIN                                   | TYP <sup>(1)</sup> | MAX   | UNIT    |    |
|--------------|--|--|---|---------------------------------------|--------------------|-------|---------|----|
| $V_{IT+}$    | Positive-going input threshold voltage     | $I_O = -8$ mA  |   |                                       |                    | 0.01  | V       |    |
| $V_{IT-}$    | Negative-going input threshold voltage     | $I_O = 8$ mA   |   | -0.2                                  |                    |       |         |    |
| $V_{hys}$    | Hysteresis voltage ( $V_{IT+} - V_{IT-}$ ) |  |   |                                       | 35                 |       | mV      |    |
| $V_{IK}$     | Enable-input clamp voltage                 | $I_I = -18$ mA   |   | -1.5                                  |                    |       | V       |    |
| $V_{OH}$     | High-level output voltage                  | $V_{ID} = 200$ mV,   | $I_{OH} = -8$ mA,                               | See <a href="#">Figure 7</a>          |                    | 4     | V       |    |
| $V_{OL}$     | Low-level output voltage                   | $V_{ID} = -200$ mV,  | $I_{OL} = 8$ mA,                                | See <a href="#">Figure 7</a>          |                    | 0.4   | V       |    |
| $I_{OZ}$     | High-impedance-state output current        | $V_O = 0$ or $V_{CC}$  | $\overline{RE}$ at $V_{CC}$                     | -1                                    |                    | 1     | $\mu$ A |    |
| $I_I$        | Bus input current                          | HVD05  | Other input at 0 V                              | $V_A$ or $V_B = 12$ V                 |                    | 0.23  | 0.5     | mA |
|              |  |  |   | $V_A$ or $V_B = 12$ V, $V_{CC} = 0$ V |                    | 0.3   | 0.5     |    |
|              |  |  |   | $V_A$ or $V_B = -7$ V                 |                    | -0.4  | 0.13    |    |
|              |  |  |   | $V_A$ or $V_B = -7$ V, $V_{CC} = 0$ V |                    | -0.4  | 0.15    |    |
|              |  | HVD06<br>HVD07   | Other input at 0 V                              | $V_A$ or $V_B = 12$ V                 |                    | 0.06  | 0.1     | mA |
|              |  |  |   | $V_A$ or $V_B = 12$ V, $V_{CC} = 0$ V |                    | 0.08  | 0.13    |    |
|              |  |  |   | $V_A$ or $V_B = -7$ V                 |                    | -0.1  | 0.05    |    |
|              |  |  |   | $V_A$ or $V_B = -7$ V, $V_{CC} = 0$ V |                    | -0.05 | 0.03    |    |
| $I_{IH}$     | High-level input current, $\overline{RE}$  | $V_{IH} = 2$ V   |   | -60                                   | 26.4               |       | $\mu$ A |    |
| $I_{IL}$     | Low-level input current, $\overline{RE}$   | $V_{IL} = 0.8$ V   |   | -60                                   | 27.4               |       | $\mu$ A |    |
| $C_{(diff)}$ | Differential input capacitance             | $V_I = 0.4 \sin(4E6\pi t) + 0.5$ V, DE at 0 V                    |   |                                       | 16                 |       | pF      |    |
| $I_{CC}$     | Supply current                             | $\overline{RE}$ at 0 V, D and DE at 0 V, No load                 | Receiver enabled and driver disabled            |                                       | 5                  | 10    | mA      |    |
|              |  | $\overline{RE}$ at $V_{CC}$ , DE at 0 V, D at $V_{CC}$ , No load | Receiver disabled and driver disabled (standby) |                                       | 1                  | 5     | $\mu$ A |    |
|              |  | $\overline{RE}$ at 0 V, D and DE at $V_{CC}$ , No load           | Receiver enabled and driver enabled             |                                       | 9                  | 15    | mA      |    |

(1) All typical values are at 25°C and with a 5-V supply.

## RECEIVER SWITCHING CHARACTERISTICS

over operating free-air temperature range unless otherwise noted

| PARAMETER          |   | TEST CONDITIONS                                     | MIN  | TYP <sup>(1)</sup> | MAX | UNIT          |
|--------------------|---|---|--|--------------------|-----|---------------|
| $t_{PLH}$          | Propagation delay time, low-to-high-level output 1/2 UL | HVD05   |  | 14.6               | 25  | ns            |
| $t_{PHL}$          | Propagation delay time, high-to-low-level output 1/2 UL | HVD05   |  | 14.6               | 25  | ns            |
| $t_{PLH}$          | Propagation delay time, low-to-high-level output 1/8 UL | HVD06   |  | 55                 | 70  | ns            |
|                    |   | HVD07   |  | 55                 | 70  |               |
| $t_{PHL}$          | Propagation delay time, high-to-low-level output 1/8 UL | HVD06   | $V_{ID} = -1.5\text{ V to }1.5\text{ V},$<br>$C_L = 15\text{ pF},$<br>See Figure 8 | 55                 | 70  | ns            |
|                    |   | HVD07   |  | 55                 | 70  |               |
| $t_{sk(p)}$        | Pulse skew ( $t_{PHL} - t_{PLH}$ )                      | HVD05   |  |                    | 2   | ns            |
|                    |   | HVD06   |  |                    | 4.5 |               |
|                    |   | HVD07   |  |                    | 4.5 |               |
| $t_{sk(pp)}^{(2)}$ | Part-to-part skew                                       | HVD05   |  |                    | 6.5 | ns            |
|                    |   | HVD06   |  |                    | 14  |               |
|                    |   | HVD07   |  |                    | 14  |               |
| $t_r$              | Output signal rise time                                 | $C_L = 15\text{ pF},$<br>See Figure 8               |  | 2                  | 3   | ns            |
| $t_f$              | Output signal fall time                                 |   |  | 2                  | 3   |               |
| $t_{PZH1}$         | Output enable time to high level                        | $C_L = 15\text{ pF},$<br>DE at 3 V,<br>See Figure 9 |  |                    | 10  | ns            |
| $t_{PZL1}$         | Output enable time to low level                         |   |  |                    | 10  |               |
| $t_{PHZ}$          | Output disable time from high level                     |   |  |                    | 15  |               |
| $t_{PLZ}$          | Output disable time from low level                      |   |  |                    | 15  |               |
| $t_{PZH2}$         | Propagation delay time, standby-to-high-level output    | $C_L = 15\text{ pF},$ DE at 0,<br>See Figure 10     |  |                    | 6   | $\mu\text{s}$ |
| $t_{PZL2}$         | Propagation delay time, standby-to-low-level output     |   |  |                    | 6   |               |

(1) All typical values are at 25°C and with a 5-V supply.

(2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## PARAMETER MEASUREMENT INFORMATION

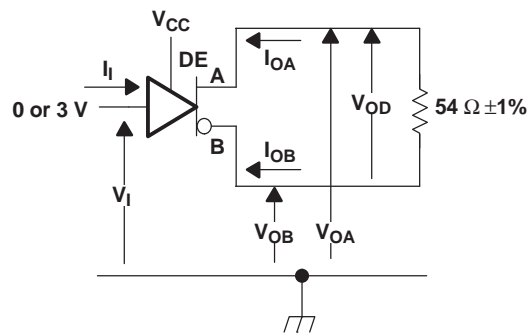


Figure 1. Driver  $V_{OD}$  Test Circuit and Voltage and Current Definitions

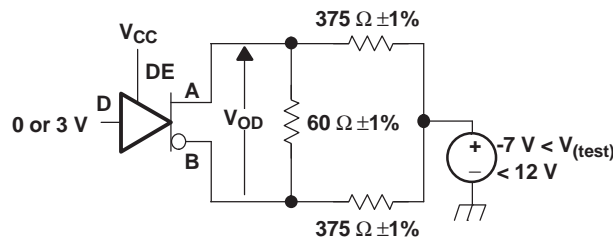
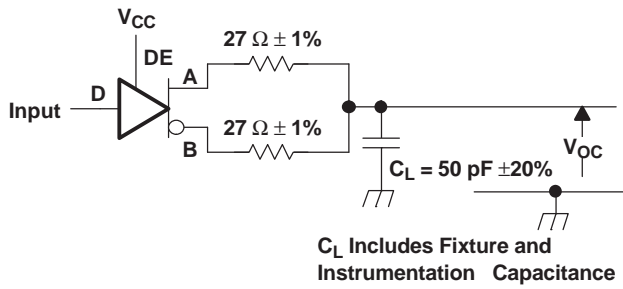
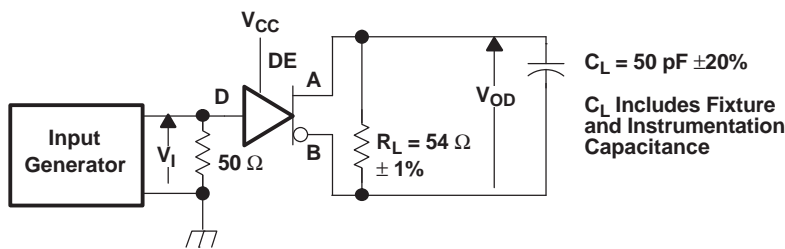
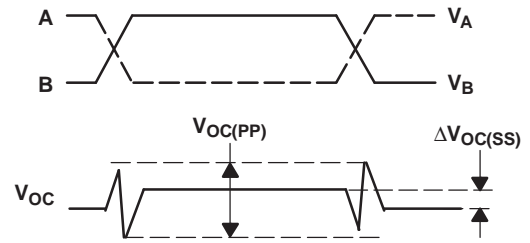


Figure 2. Driver  $V_{OD}$  With Common-Mode Loading Test Circuit



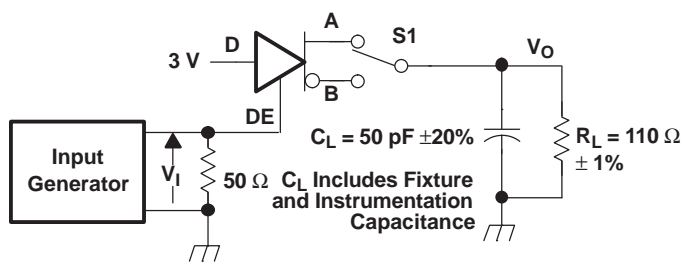
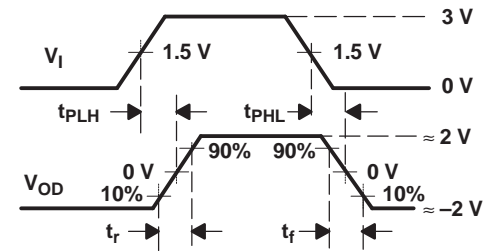
Input: PRR = 500 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_O = 50 \Omega$

Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage



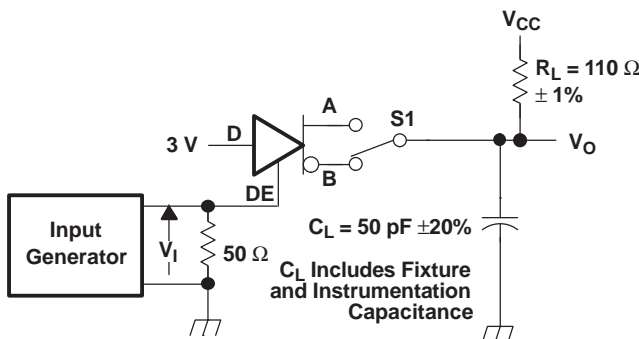
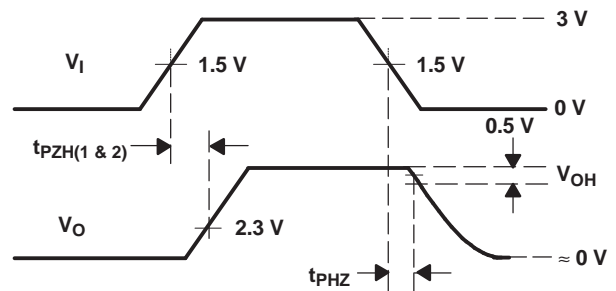
Generator: PRR = 500 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_O = 50 \Omega$

Figure 4. Driver Switching Test Circuit and Voltage Waveforms



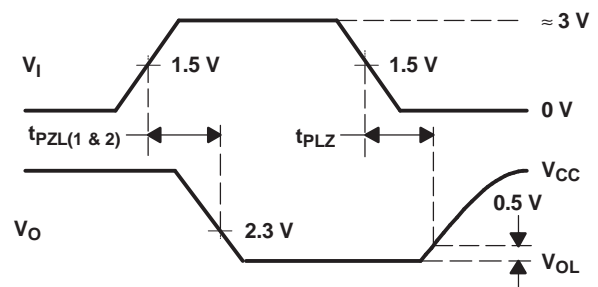
Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_O = 50 \Omega$

Figure 5. Driver High-Level Enable and Disable Time Test Circuit and Voltage Waveforms



Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_O = 50 \Omega$

Figure 6. Driver Low-Level Output Enable and Disable Time Test Circuit and Voltage Waveforms



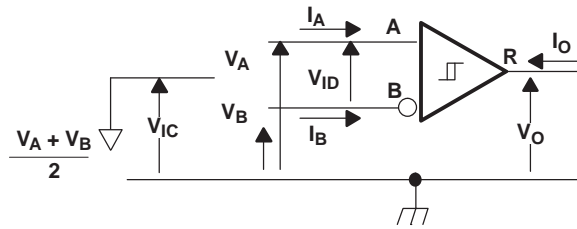


Figure 7. Receiver Voltage and Current Definitions

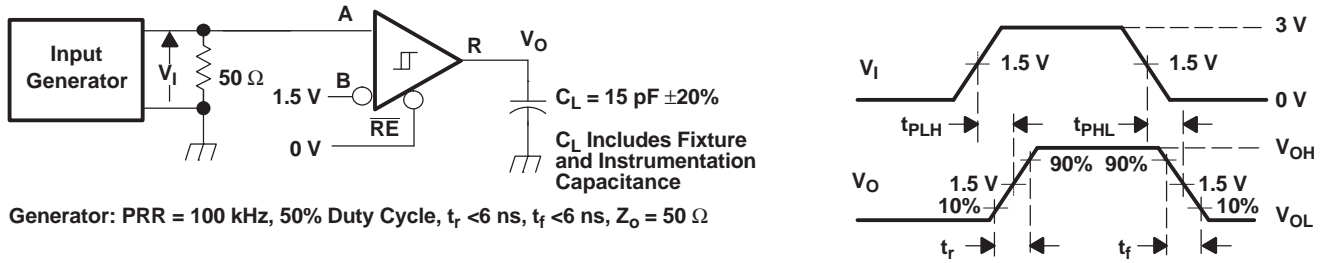


Figure 8. Receiver Switching Test Circuit and Voltage Waveforms



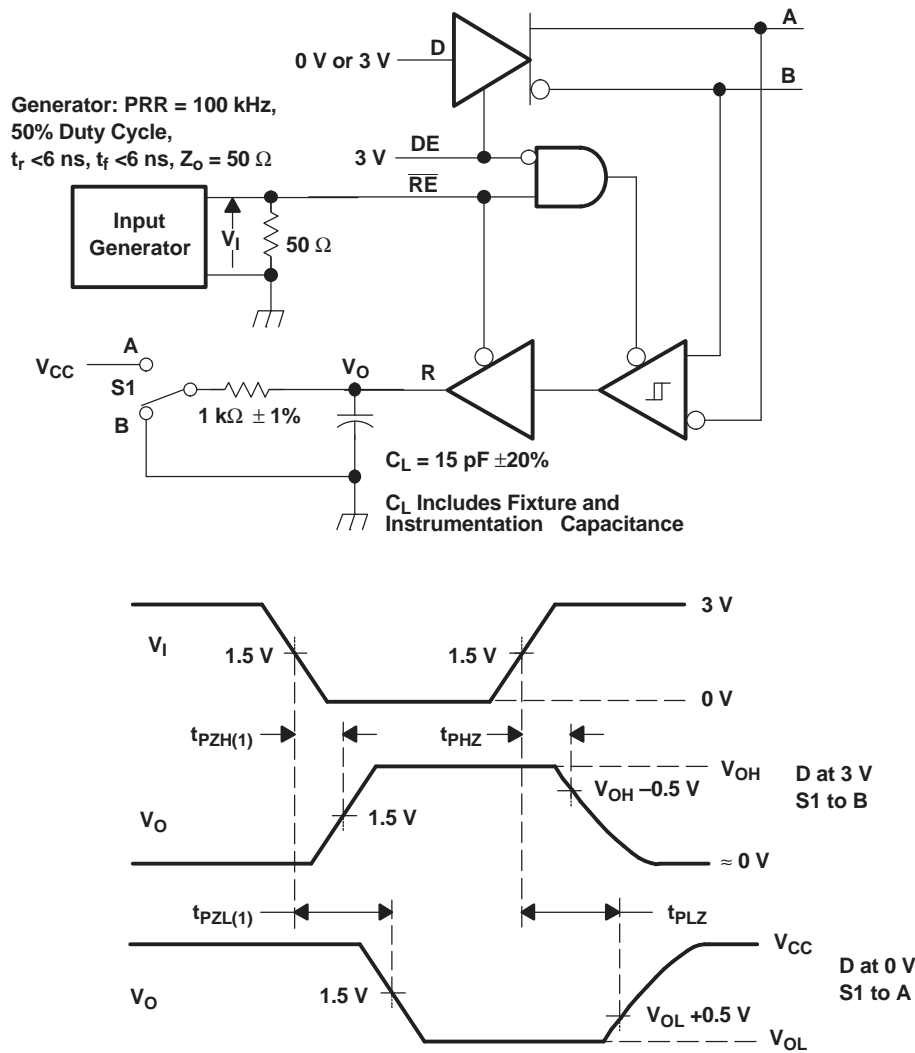


Figure 9. Receiver Enable and Disable Time Test Circuit and Voltage Waveforms With Drivers Enabled

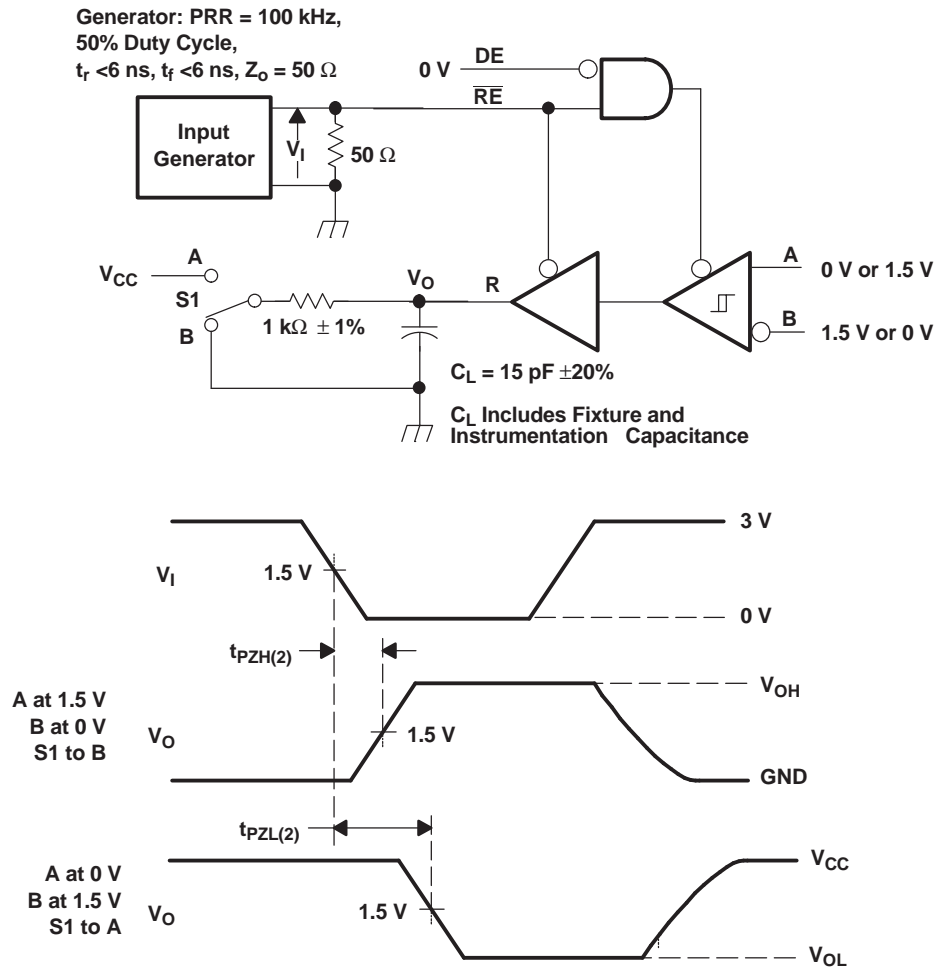
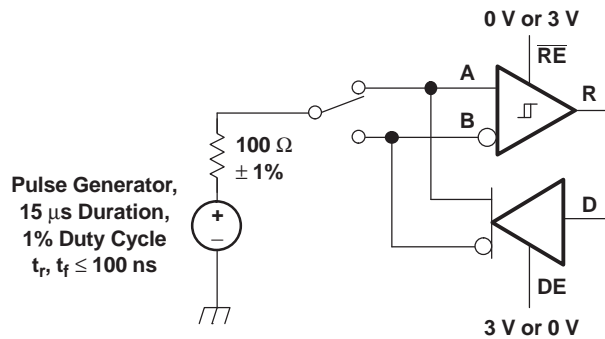


Figure 10. Receiver Enable Time From Standby (Driver Disabled)



NOTE: This test is conducted to test survivability only. Data stability at the R output is not specified.

Figure 11. Test Circuit, Transient Over Voltage Test

## FUNCTION TABLES

### DRIVER

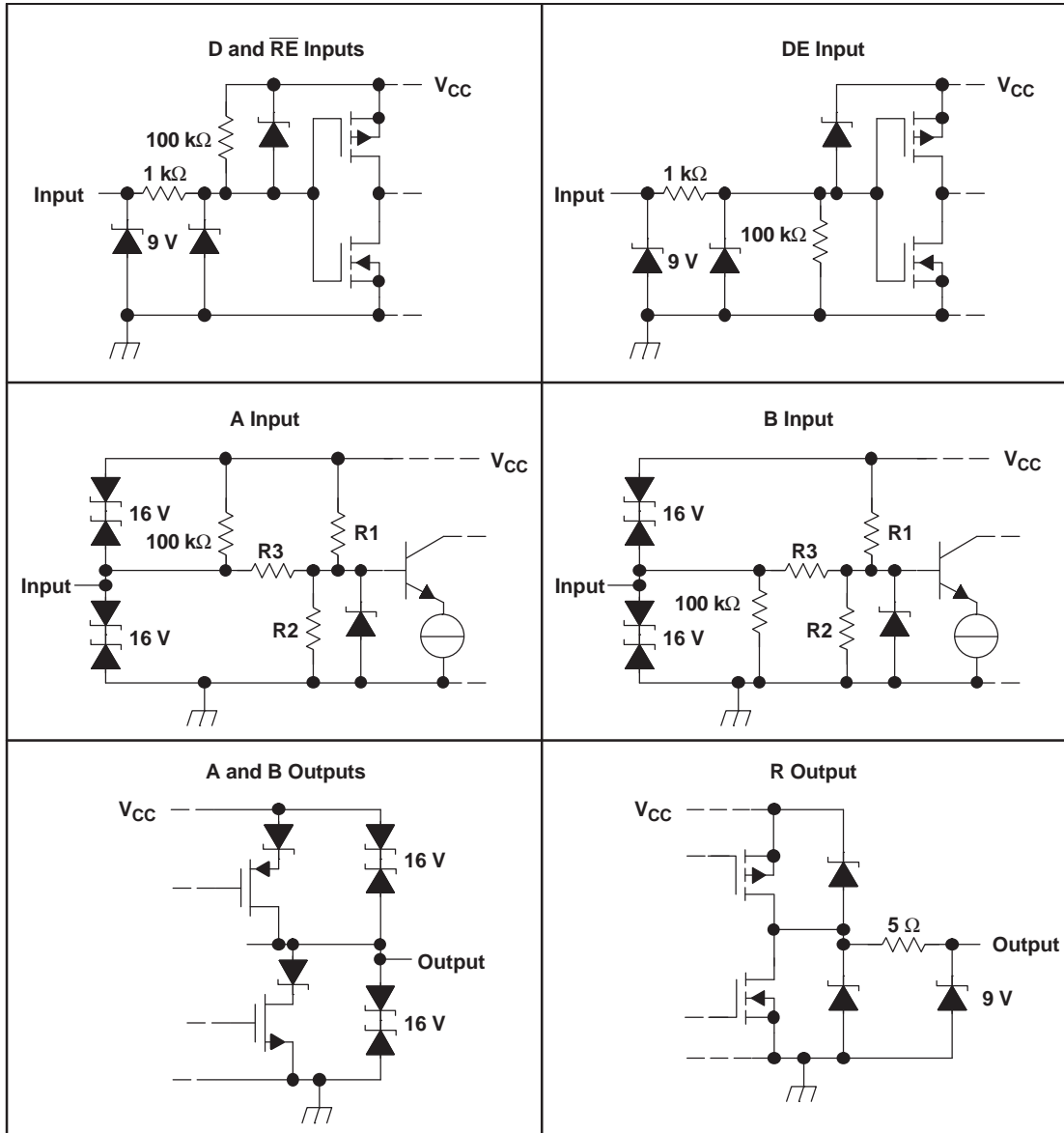
| INPUT<br>D | ENABLE<br>DE | OUTPUTS |   |
|------------|--------------|---------|---|
|            |              | A       | B |
| H          | H            | H       | L |
| L          | H            | L       | H |
| X          | L            | Z       | Z |
| Open       | H            | H       | L |
| X          | Open         | Z       | Z |

### RECEIVER<sup>(1)</sup>

| DIFFERENTIAL INPUTS<br>$V_{ID} = V_A - V_B$ | ENABLE<br>$\overline{RE}$ | OUTPUT<br>R |
|---|---------------------------|-------------|
| $V_{ID} \leq -0.2$ V                        | L                         | L           |
| $-0.2$ V < $V_{ID}$ < $-0.01$ V             | L                         | ?           |
| $-0.01$ V $\leq V_{ID}$                     | L                         | H           |
| X   | H                         | Z           |
| Open Circuit                                | L                         | H           |
| Short Circuit                               | L                         | H           |
| X   | Open                      | Z           |

- (1) H = high level; L = low level; Z = high impedance; X = irrelevant;  
? = indeterminate

EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



|           | R1/R2 | R3     |
|-----------|-------|--------|
| SN65HVD05 | 9 kΩ  | 45 kΩ  |
| SN65HVD06 | 36 kΩ | 180 kΩ |
| SN65HVD07 | 36 kΩ | 180 kΩ |

TYPICAL CHARACTERISTICS

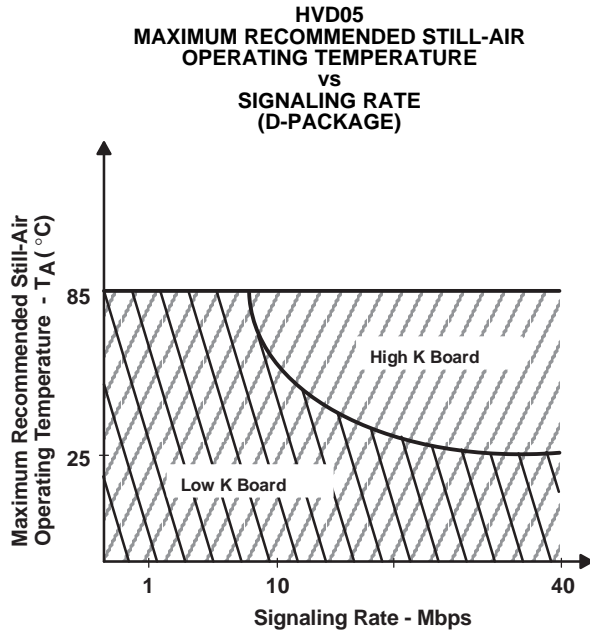


Figure 12.

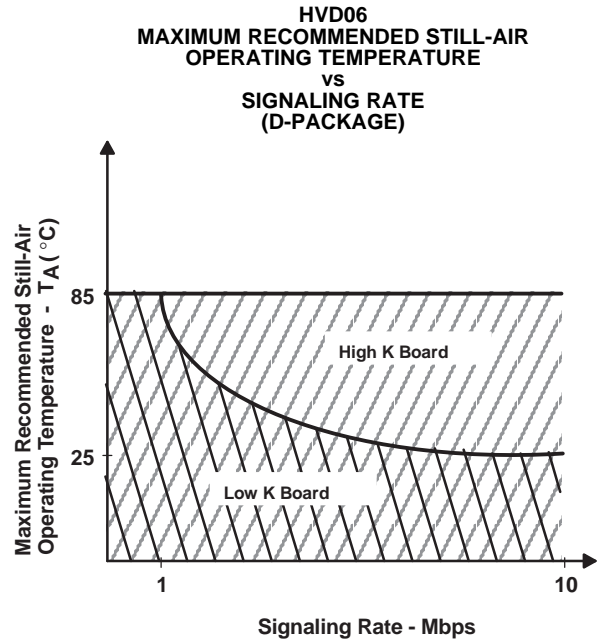


Figure 13.

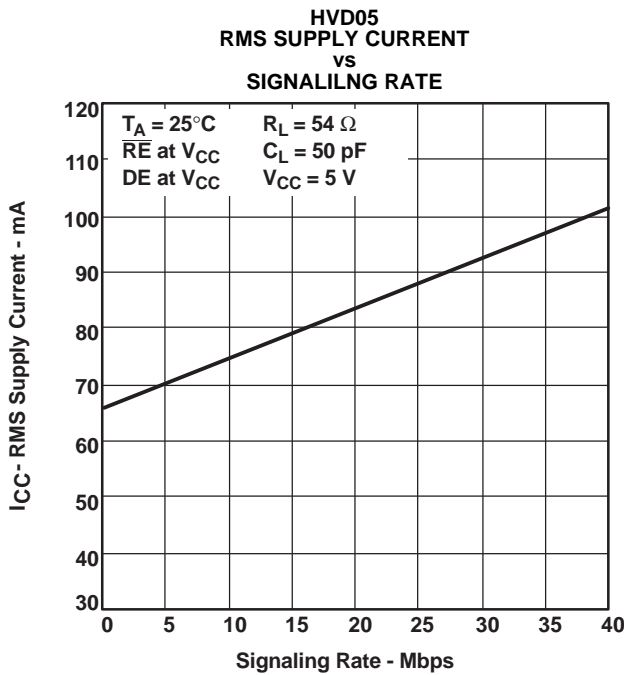


Figure 14.

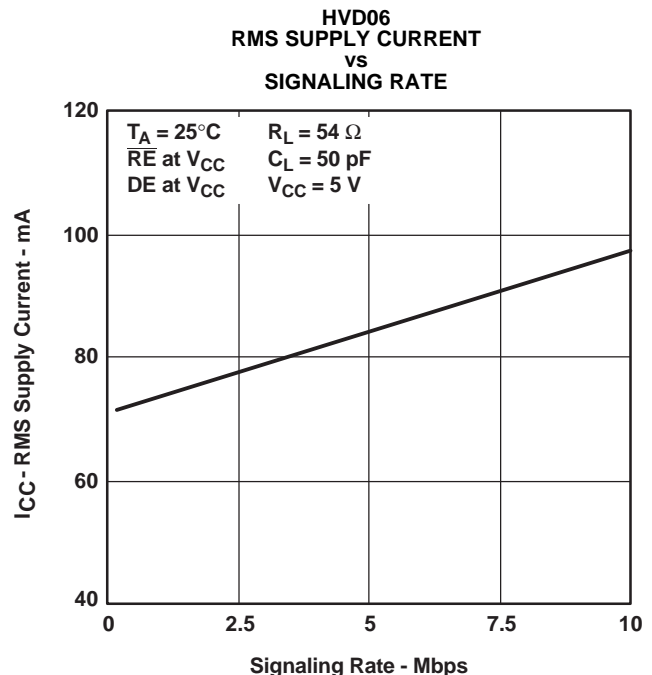
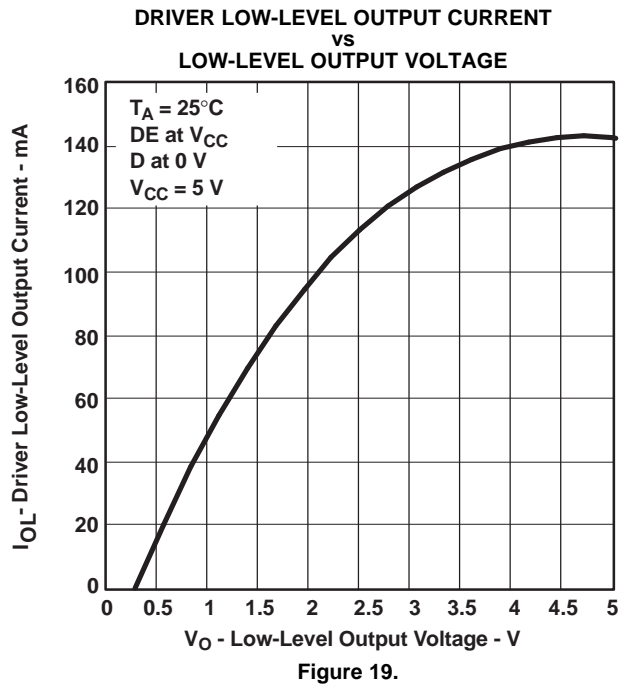
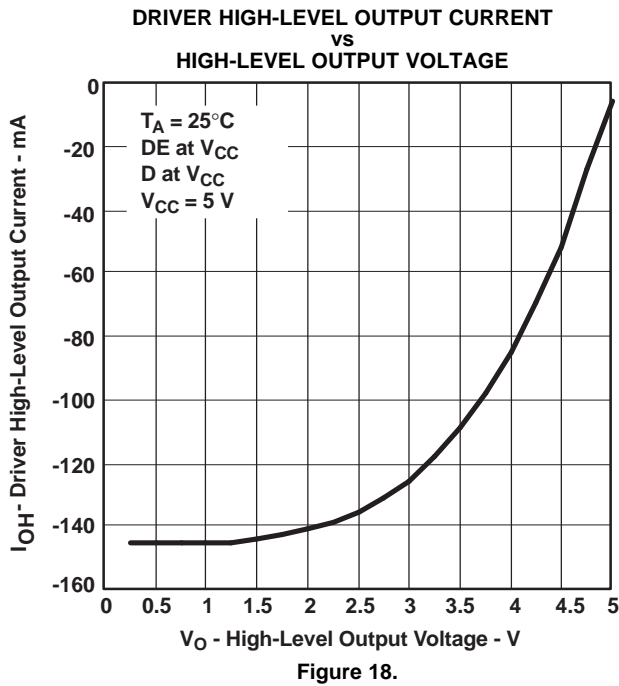
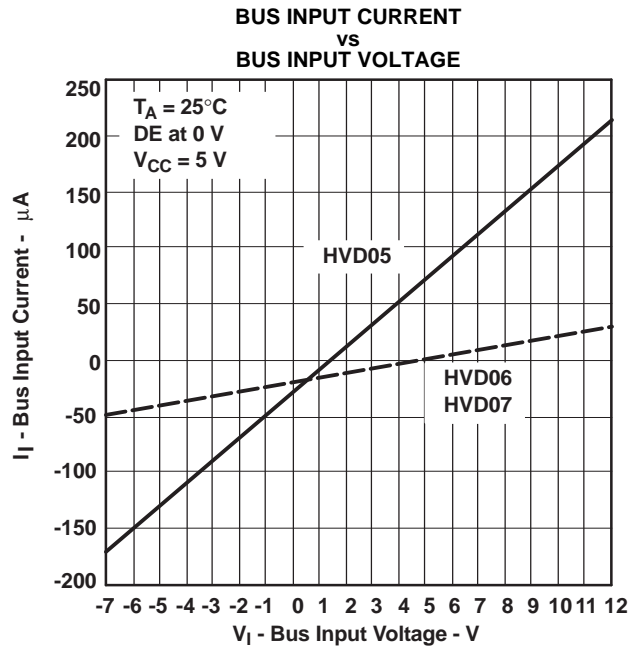
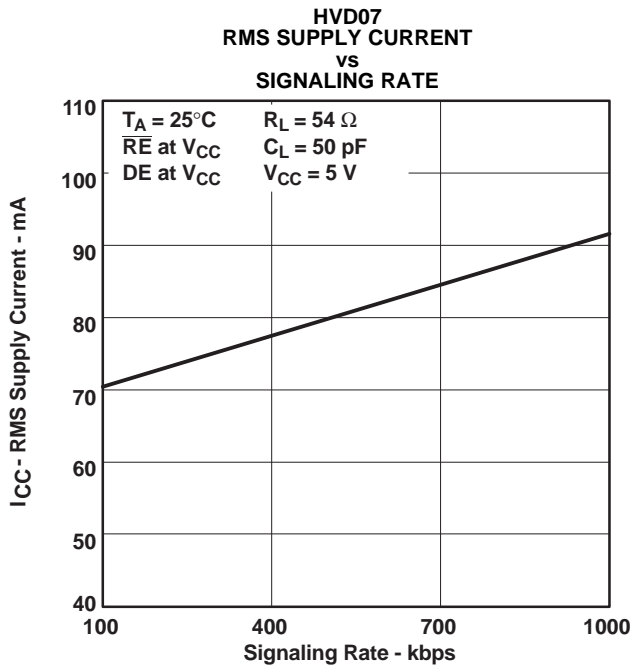


Figure 15.

TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

DIFFERENTIAL OUTPUT VOLTAGE  
vs  
FREE-AIR TEMPERATURE

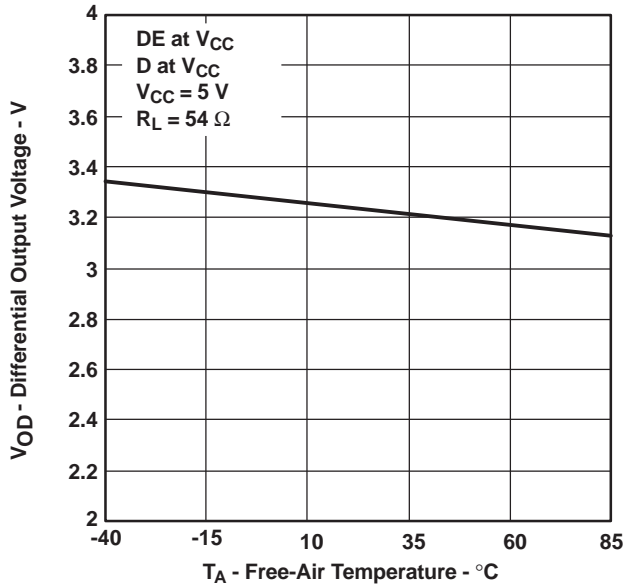


Figure 20.

DRIVER OUTPUT CURRENT  
vs  
SUPPLY VOLTAGE

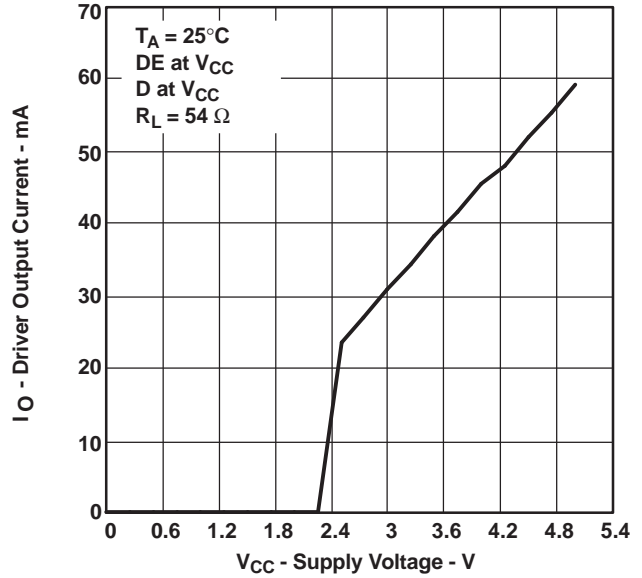


Figure 21.

DIFFERENTIAL OUTPUT VOLTAGE  
vs  
DIFFERENTIAL OUTPUT CURRENT

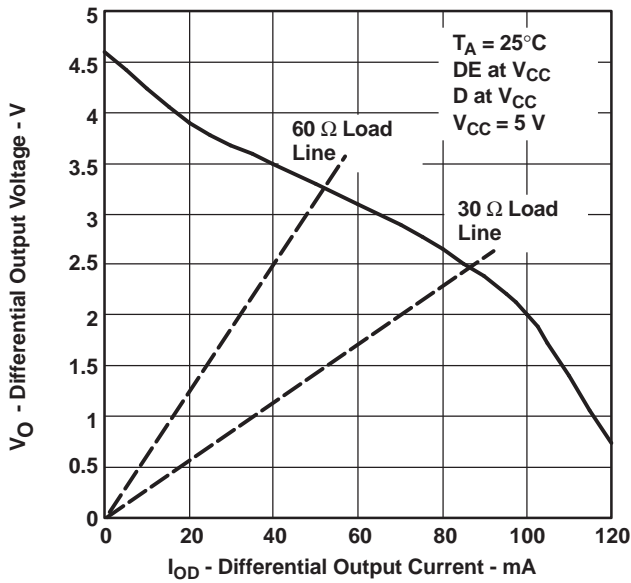


Figure 22.

ENABLE TIME  
vs  
COMMON-MODE VOLTAGE (SEE Figure 24)

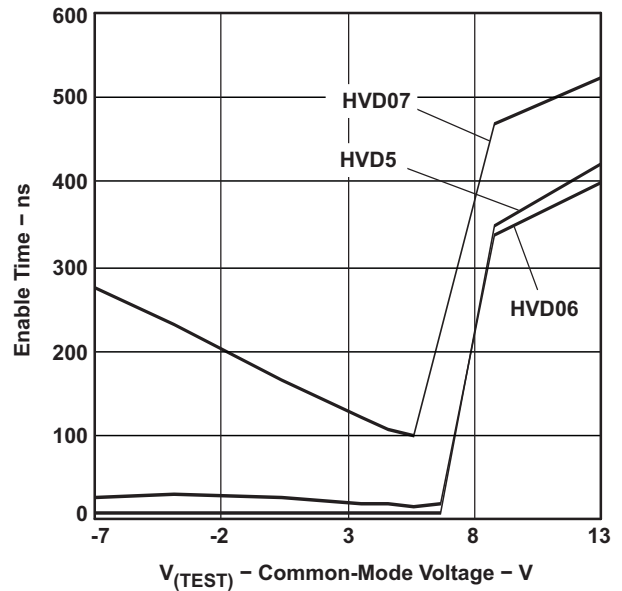


Figure 23.

TYPICAL CHARACTERISTICS (continued)

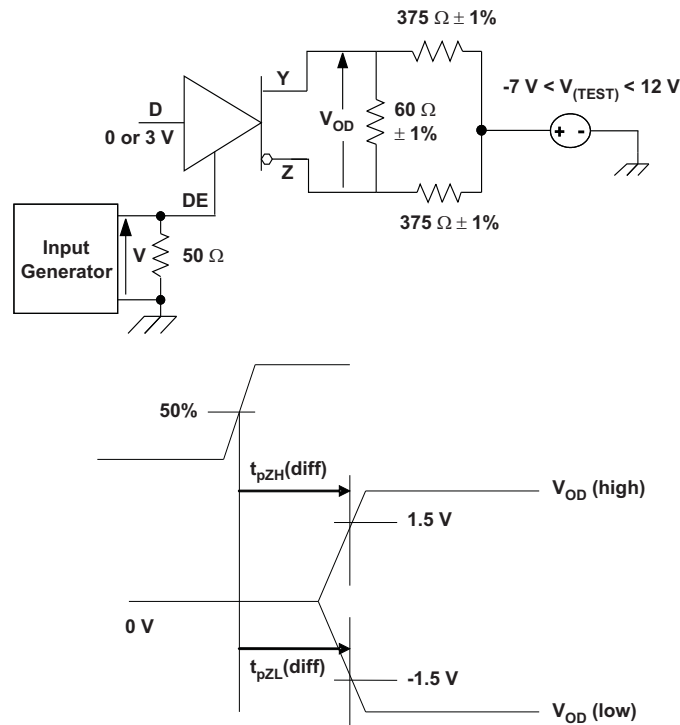
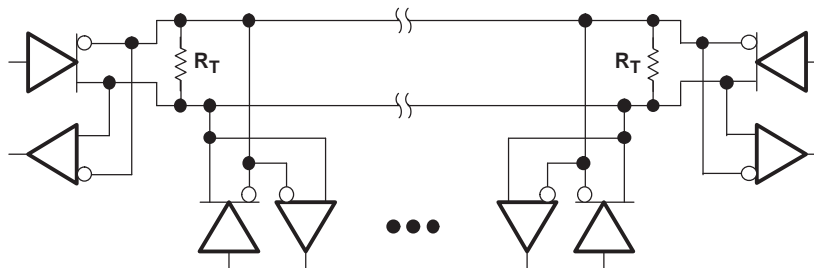


Figure 24. Driver Enable Time From DE to  $V_{OD}$

The time  $t_{pZL}(x)$  is the measure from DE to  $V_{OD}(x)$ .  $V_{OD}$  is valid when it is greater than 1.5 V.



**APPLICATION INFORMATION**



| Device | Number of Devices on Bus |
|--------|--------------------------|
| HVD05  | 64                       |
| HVD06  | 256                      |
| HVD07  | 256                      |

NOTE: The line should be terminated at both ends with its characteristic impedance ( $R_T = Z_0$ ).  
Stub lengths off the main line should be kept as short as possible.

**Figure 25. Typical Application Circuit**

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN65HVD05D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD05DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD05DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD05DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD05P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN65HVD05PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN65HVD06D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD06DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD06DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD06DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD06P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN65HVD06PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN65HVD07D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD07DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD07DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD07DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD07P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN65HVD07PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD05D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD05DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD05DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD05DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD05P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD05PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD06D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN75HVD06DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD06DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD06DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD06P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD06PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD07D       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD07DG4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD07DR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD07DRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN75HVD07P       | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN75HVD07PE4     | ACTIVE                | PDIP         | P               | 8    | 50          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



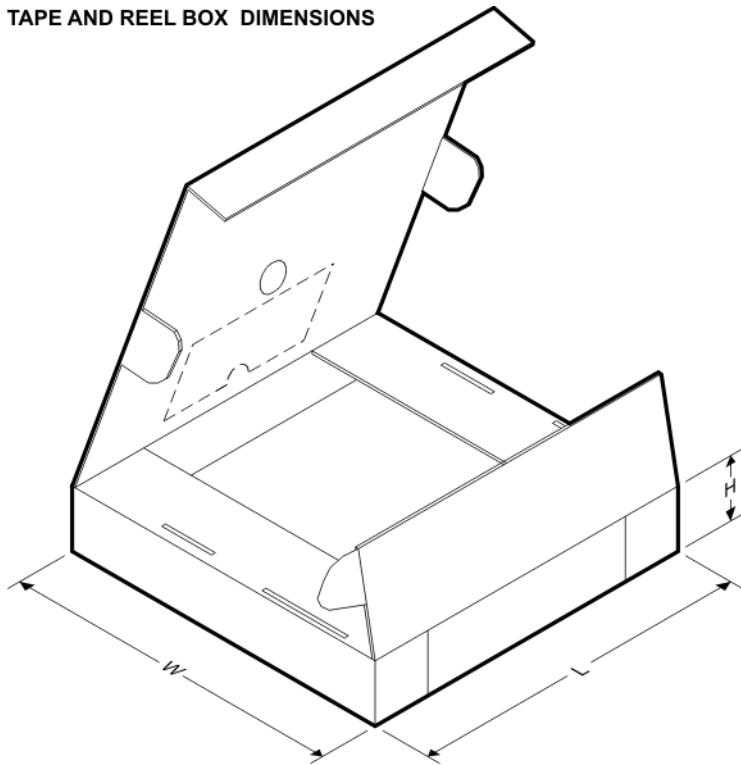
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN65HVD05DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD06DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD07DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN75HVD05DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN75HVD06DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN75HVD07DR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**

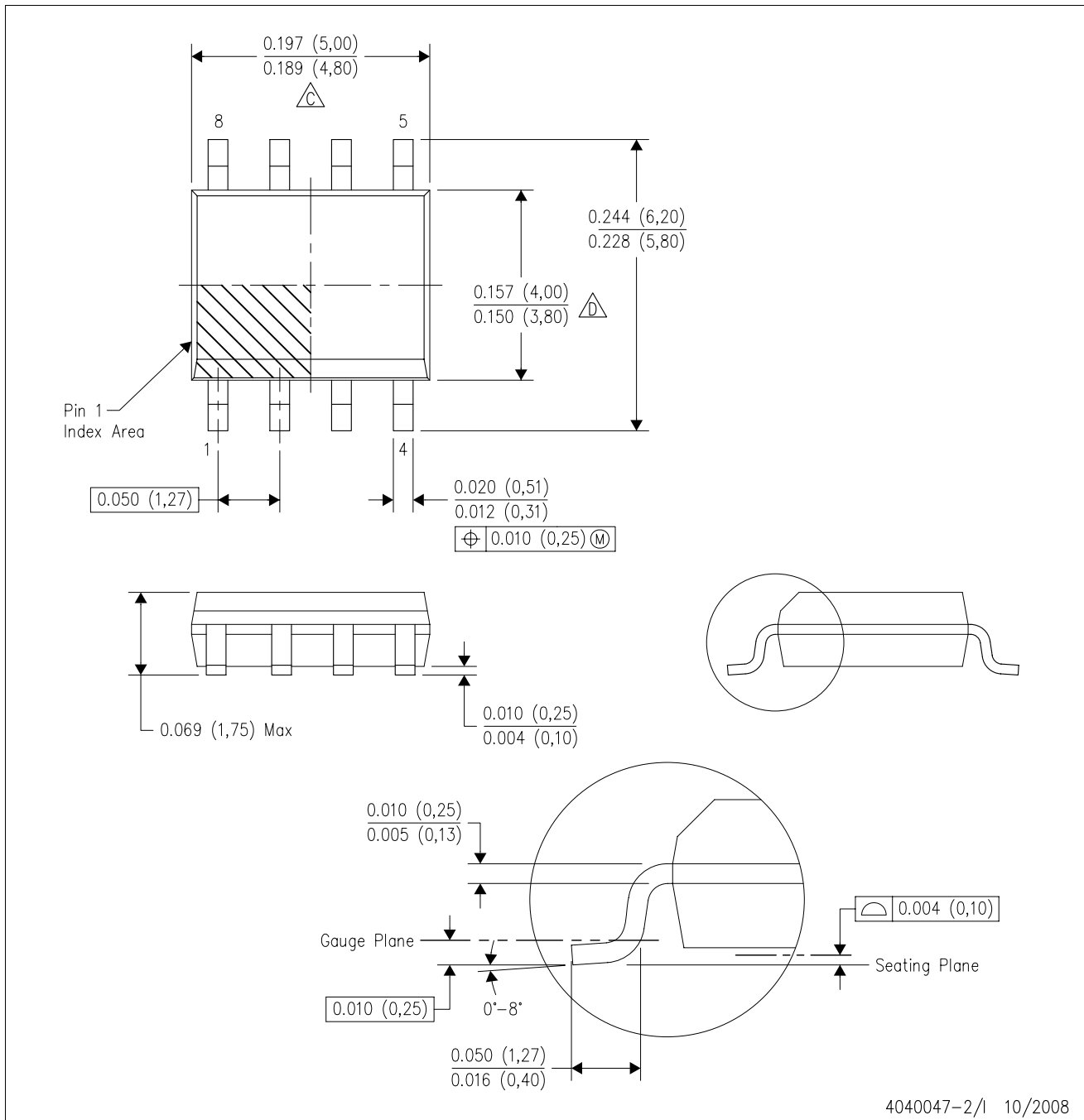


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65HVD05DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| SN65HVD06DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| SN65HVD07DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| SN75HVD05DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| SN75HVD06DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| SN75HVD07DR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |

D (R-PDSO-G8)

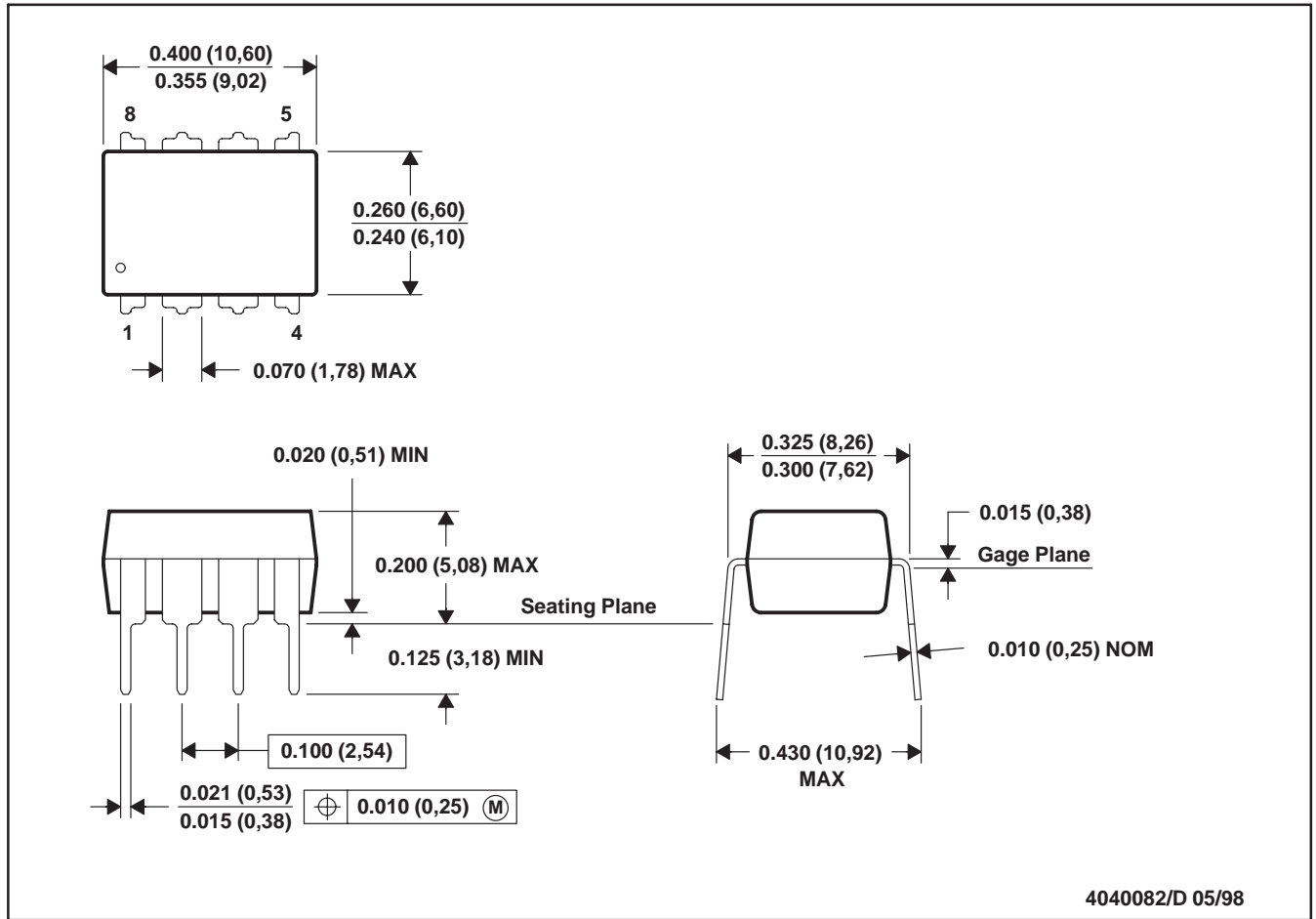
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
  - E. Reference JEDEC MS-012 variation AA.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-001

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| DSP                         | <a href="http://dsp.ti.com">dsp.ti.com</a>                         |
| Clocks and Timers           | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>           |
| Interface                   | <a href="http://interface.ti.com">interface.ti.com</a>             |
| Logic                       | <a href="http://logic.ti.com">logic.ti.com</a>                     |
| Power Mgmt                  | <a href="http://power.ti.com">power.ti.com</a>                     |
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| RF/IF and ZigBee® Solutions | <a href="http://www.ti.com/lprf">www.ti.com/lprf</a>               |

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|                    |  |
|--------------------|--|
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